# 捷多邦,专业PCB打样工厂,24小时加急出货

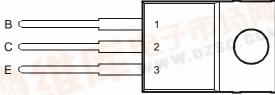
# BD540, BD540A, BD540B, BD540C PNP SILICON POWER TRANSISTORS

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JUNE 1973 - REVISED MARCH 1997

- Designed for Complementary Use with the BD539 Series
- 45 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Customer-Specified Selections Available

# TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base

MDTRACA

# absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING			VALUE	UNIT	
	BD540		-40		
Callanter have valtered (I = 0)	BD540A	V	-60		
Collector-base voltage (I <sub>E</sub> = 0)	BD540B	V <sub>CBO</sub>	-80	V	
	BD540C	WWW.	-100		
	BD540		-40		
Collector-emitter voltage (I <sub>B</sub> = 0) (see Note 1)	BD540A		-60	V	
	BD540B	V <sub>CEO</sub>	-80	V	
	BD540C		-100		
Emitter-base voltage	V <sub>EBO</sub>	-5	V		
Continuous collector current			-5	Α	
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			45	W	
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W	
Operating free air temperature range			-65 to +150	°C	
Operating junction temperature range			-65 to +150	°C	
Storage temperature range			-65 to +150	°C	
Lead temperature 3.2 mm from case for 10 seconds			260	°C	

- NOTES: 1. These values apply when the base-emitter diode is open circuited.
  - 2. Derate linearly to 150°C case temperature at the rate of 0.36 W/°C.
  - 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.







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# electrical characteristics at 25°C case temperature

PARAMETER			TEST CONDITION	DITIONS MIN			MAX	UNIT
V <sub>(BR)CEO</sub>	Collector-emitter breakdown voltage	I <sub>C</sub> = -30 mA	1 0	BD540 BD540A	-40 -60			V
		breakdown voltage	(see Note 4)	BD540B BD540C	-80 -100			V
I <sub>CES</sub>	Collector-emitter cut-off current	$V_{CE} = -40 \text{ V}$ $V_{CE} = -60 \text{ V}$ $V_{CE} = -80 \text{ V}$ $V_{CE} = -100 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD540 BD540A BD540B BD540C			-0.2 -0.2 -0.2 -0.2	mA
I <sub>CEO</sub>	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_{B} = 0$ $I_{B} = 0$	BD540/540A BD540B/540C			-0.3 -0.3	mA
I <sub>EBO</sub>	Emitter cut-off current	V <sub>EB</sub> = -5 V	I <sub>C</sub> = 0				-1	mA
h <sub>FE</sub>	Forward current transfer ratio	$V_{CE} = -4 V$ $V_{CE} = -4 V$ $V_{CE} = -4 V$	$I_{C} = -0.5 \text{ A}$ $I_{C} = -1 \text{ A}$ $I_{C} = -3 \text{ A}$	(see Notes 4 and 5)	40 30 12			
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$I_B = -125 \text{ mA}$ $I_B = -375 \text{ mA}$ $I_B = -1 \text{ A}$	O	(see Notes 4 and 5)			-0.25 -0.8 -1.5	V
V <sub>BE</sub>	Base-emitter voltage	V <sub>CE</sub> = -4 V	I <sub>C</sub> = -3 A	(see Notes 4 and 5)			-1.25	V
h <sub>fe</sub>	Small signal forward current transfer ratio	V <sub>CE</sub> = -10 V	I <sub>C</sub> = -0.5 A	f = 1 kHz	20			
h <sub>fe</sub>	Small signal forward current transfer ratio	V <sub>CE</sub> = -10 V	I <sub>C</sub> = -0.5 A	f = 1 MHz	3			

NOTES: 4. These parameters must be measured using pulse techniques,  $t_p$  = 300  $\mu$ s, duty cycle  $\leq$  2%.

# thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.78	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

# resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t <sub>on</sub>	Turn-on time	I <sub>C</sub> = -1 A	$I_{B(on)} = -0.1 A$	$I_{B(off)} = 0.1 A$		0.3		μs
t <sub>off</sub>	Turn-off time	$V_{BE(off)} = 4.3 V$	$R_L = 30 \Omega$	$t_p$ = 20 $\mu$ s, dc $\leq$ 2%		1		μs

 $<sup>^{\</sup>dagger} \ \ \mbox{Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.}$ 

<sup>5.</sup> These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

# **TYPICAL CHARACTERISTICS**

# TYPICAL DC CURRENT GAIN VS COLLECTOR CURRENT $T_{CS632AH}$ $T_{C} = 25^{\circ}C$ $T_{C} = 300 \,\mu s$ , duty cycle < 2% $T_{C} = 80^{\circ}C$ $T_{C} = 80^{\circ}C$ $T_{C} = 10$ $T_{C} = 10$ $T_{C} = 10$ $T_{C} = 10$

Figure 1.

# COLLECTOR-EMITTER SATURATION VOLTAGE vs

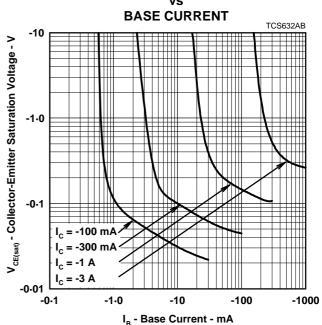


Figure 2.

# **BASE-EMITTER VOLTAGE**

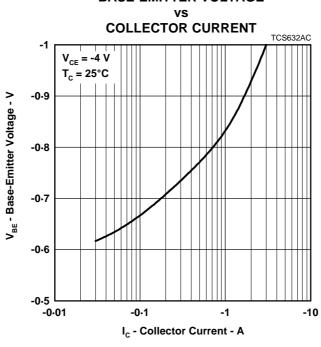
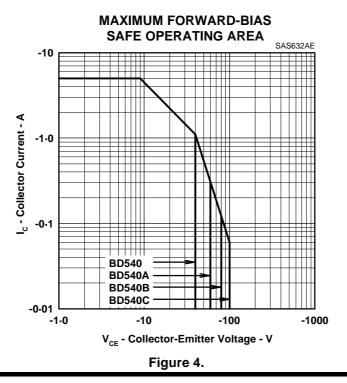


Figure 3.



# **MAXIMUM SAFE OPERATING REGIONS**



# THERMAL INFORMATION

# **MAXIMUM POWER DISSIPATION**

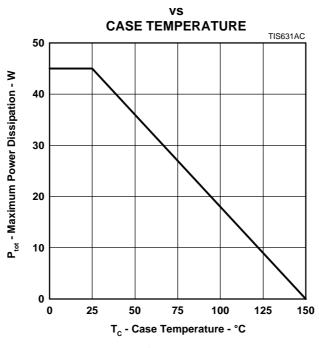


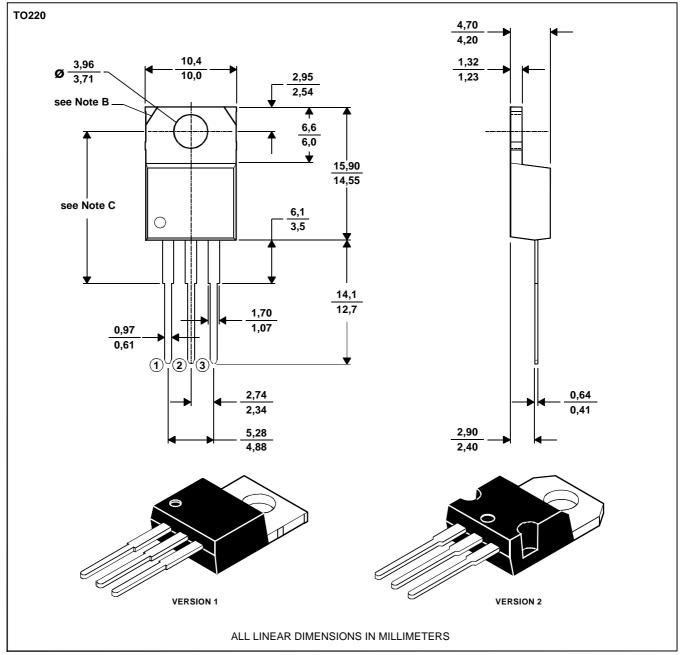
Figure 5.

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# **MECHANICAL DATA**

# TO-220 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. MDXXBE



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